0.2A SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Leadless Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at https://www.diodes.com/products/automotive/automotive-products/.**
- **This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability. https://www.diodes.com/quality/product-definitions/**

Mechanical Data

- Package: X2-DFN1006-2
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Marking Information
- Terminal Finish – NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e4
- Weight: 0.001 grams (Approximate)

X2-DFN1006-2

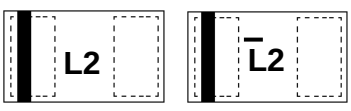
Bottom View

Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
BAT54LPS-7	X2-DFN1006-2	3,000	Tape & Reel

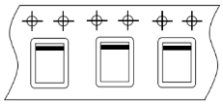
Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Bar Denotes Cathode Side

L2 & $\overline{L2}$ = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	V
Forward Continuous Current	I_F	200	mA
Repetitive Peak Forward Current	I_{FRM}	300	mA
Forward Surge Current @ t < 1.0s	I_{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	250	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{\theta JA}$	400	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	30	—	—	V	I_R = 100µA
Forward Voltage	V_F	— — — —	— — 428 580	320 400 500 650	mV	I_F = 1mA I_F = 10mA I_F = 30mA I_F = 100mA
Reverse Leakage Current (Note 6)	I_R	—	—	2.0	µA	V_R = 25V
Total Capacitance	C_T	—	—	10	pF	V_R = 1.0V, f = 1.0MHz
Reverse Recovery Time	t_{RR}	—	—	5.0	ns	I_F = 10mA through I_R = 10mA to I_R = 1.0mA, R_L = 100Ω

Notes: 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
6. Short duration pulse test used to minimize self-heating effect.

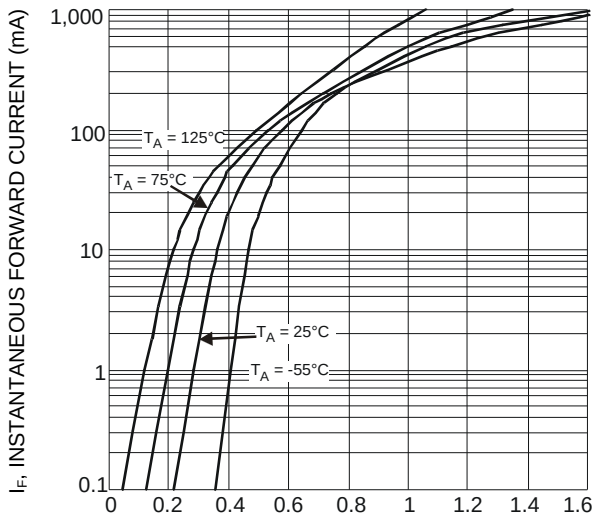


Figure 1 Typical Forward Characteristics

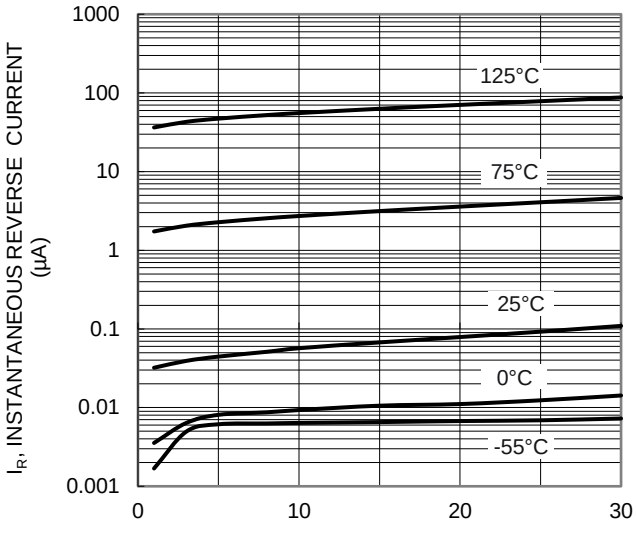


Figure 2 Typical Reverse Characteristics

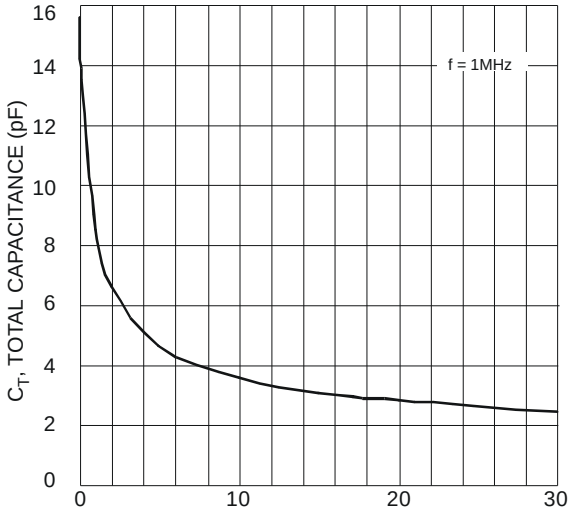


Figure 3 Typical Total Capacitance

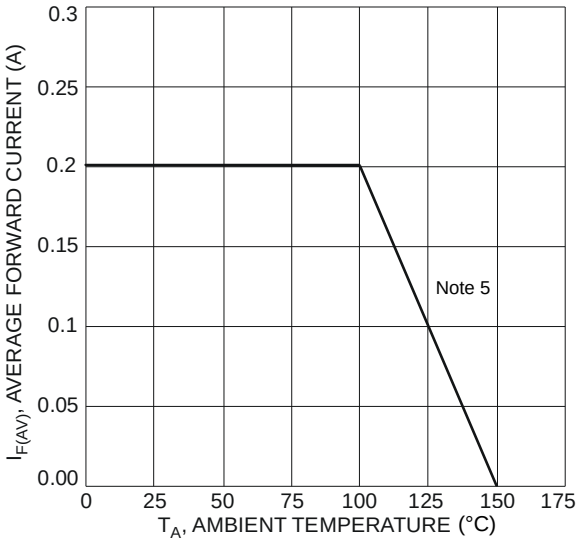


Figure 4 Forward Current Derating Curve

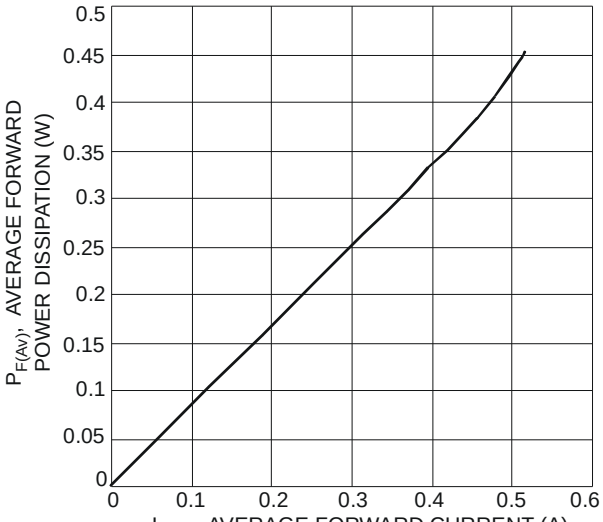


Figure 5 Forward Power Dissipation

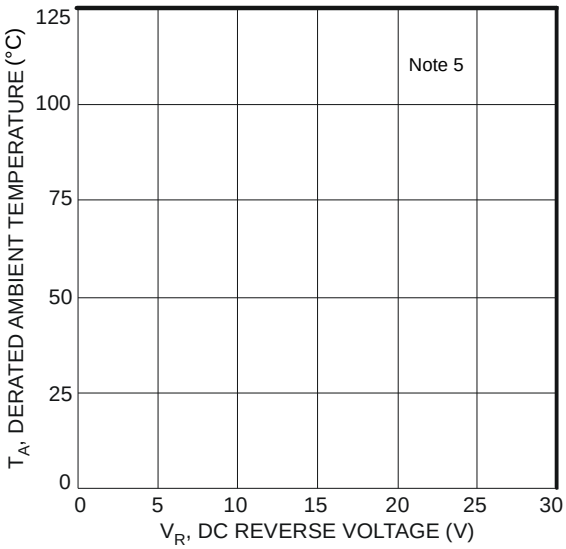


Figure 6 Operating Temperature Derating

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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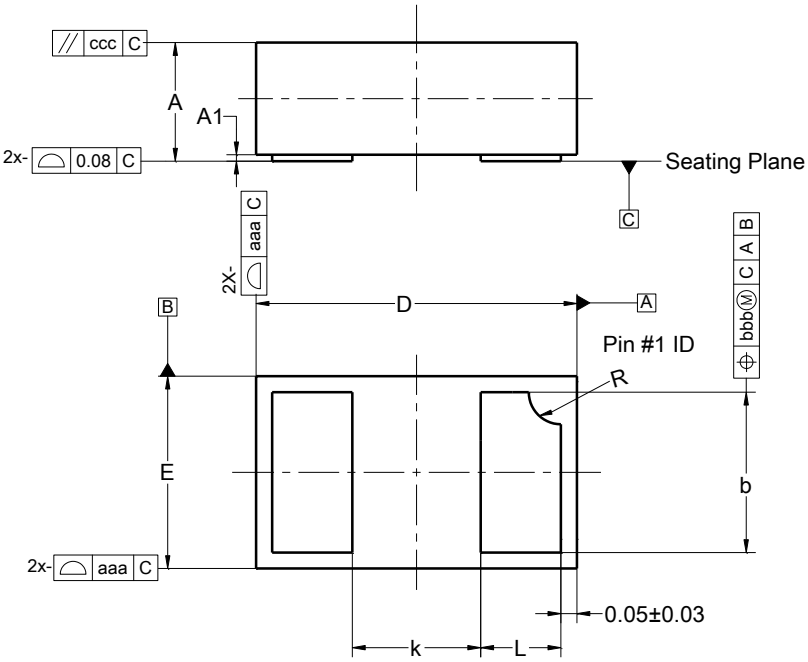
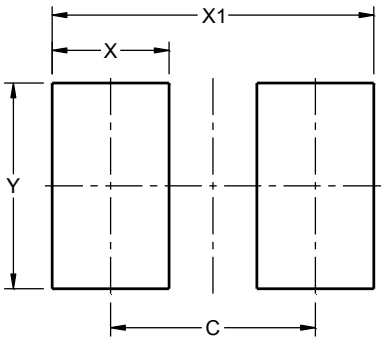


X2-DFN1006-2			
Dim	**Min**	**Max**	**Typ**
A	0.34	0.40	0.37
A1	0.00	0.05	0.03
b	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
k	—	—	0.40
L	0.20	0.30	0.25
R	—	—	0.10
aaa	0.15		
bbb	0.05		
ccc	0.05		
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-2



Dimensions	Value (in mm)
C	0.70
X	0.40
X1	1.10
Y	0.70

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